## ■ Tetra-Lateral PSD's

#### Position Sensing Detectors (PSD)

Tetra-lateral position sensing detectors are manufactured with one single resistive layer for both one and two dimensional measurements. They feature a common anode and two cathodes for one dimensional position sensing or four cathodes for two dimensional position sensing.

These detectors are best when used in applications that require measurement over a wide spacial range. They offer high response uniformity, low dark current, and good position linearity over 64% of the sensing area.

A reverse bias should be applied to these detectors to achieve optimum current linearity when large light signals are present. The circuit on the opposite page represents a typical circuit set up for two dimensional tetra-lateral PSDs.

For further details as well as the set up for one dimensional PSDs refer to the "Photodiode Characteristics" section of the catalog. Note that the maximum recommended incident power density is 10 mW / cm<sup>2</sup>. Furthermore, typical uniformity of response for a 1 mm  $\phi$  spot size is  $\pm$  5% for SC-25D and SC-50D and  $\pm$  2% for all other tetra-lateral devices.



#### APPLICATIONS

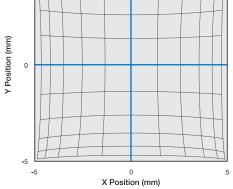
- Tool Alignment and Control
- Leveling Measurements
- Angular Measurements
- 3 Dimensional Vision
- Position Measuring

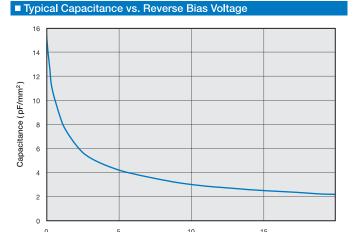
#### FEATURES

- Single Resistivity Layer
- High Speed Response
- High Dynamic Range
- Very High Resolution
- Spot Size & Shape Independence

# SC-10D, 50µm Spot

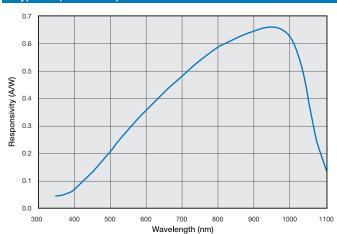
■ Typical Position Detectability



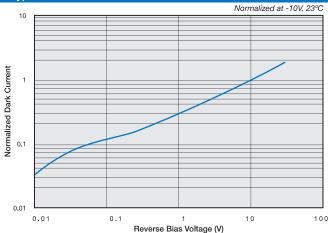


Reverse Bias Voltage (V)

## ■ Typical Spectral Response



## ■ Typical Dark Current vs. Reverse Bias

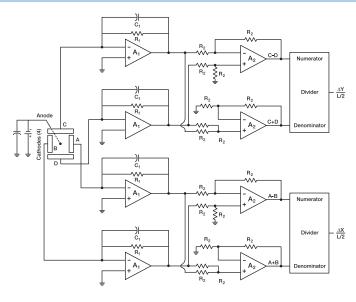


## ■ Tetra-Lateral Position Sensors

Typical Electro-Optical Specifications at T<sub>A</sub>=23°C

Model Number	Position Sensing Area		Responsivity (A/W)		Absolute Position Detection Error (mm)	Dark Current (μΑ)		Capacitance (pF)	Rise Time † (µs)	Inter- electrode Resistance (kΩ)		Temp.* Range (°C)		Package	
	Area (mm²)	Dimension (mm)	670 nm		Over 80% of Length 64% of Area	-15 V		-15 V	-15 V 670 nm 50Ω			Operating	Storage	Style ¶	
			min.	typ.	typ.	typ.	max.	typ.	typ.	min.	max.	Ö	Ó		
One-Di	One-Dimensional Series, Plastic Package														
LSC-5D	11.5	5.3 x 2.2	0.35	0.42	0.040	0.01	0.10	50	0.25	2	50	-10 ~ +60	-20 ~ +70	47 / Plastic	
LSC-30D	122	30 x 4.1			0.240	0.025	0.250	300	3.00	4	100			46 / Plastic	
Two-Di	men	sional S	Series	s, Me	tal Packag	е									
SC-4D	6.45	2.54 sq	0.35	0.42	0.080	0.005	0.050	20	0.66	. 3	30	0 ~ +20	-20 ~ +80	41 / TO-5	
SC-10D	103	10.16 sq			1.30	0.025	0.250	300	1.00					44 / Special	
SC-25D	350	18.80 sq			2.5	0.10	1.0	1625	5.00					45 / Special	
SC-50D	957	30.94 sq			5.0	0.25	2.5	3900	13.00					21 / Special	
Two Di	Two Dimensional Series, Plastic Package §														
FIL-C4DG	6.45	2.54 sq	0.35	0.42	0.080	0.005	0.050	20	0.66	3	30	+60	+70	14 / Plastic	
FIL-C10DG	103	10.16 sq			1.30	0.025	0.250	300	1.00		30	-10 ~	-20 ~	15 / Plastic	

Chip centering within  $\pm$  0.010".



For further details, refer to the "Photodiode Characteristics" section of the catalog.

<sup>†</sup> Rise time specifications are with a 1 mm spot size at the center of the device. § The photodiode chips in "FIL" series are isolated in a low profile plastic package. They have a large field of view as well as "in line" pins.

<sup>|</sup> For mechanical drawings please refer to pages 58 thru 69.
| Non-Condensing temperature and Storage Range, Non-Condensing Environment.

### 1. Parameter Definitions:

- A = Distance from top of chip to top of glass.
- a = Photodiode Anode.
- B = Distance from top of glass to bottom of case.
- c = Photodiode Cathode
- (Note: cathode is common to case in metal package products unless otherwise noted).
- W = Window Diameter.
- F.O.V. = Filed of View (see definition below).
- 2. Dimensions are in inches (1 inch = 25.4 mm).
- 3. Pin diameters are 0.018 ± 0.002" unless otherwise specified.
- 4. Tolerances (unless otherwise noted)

General: 0.XX ±0.01"

0.XXX ±0.005"

Chip Centering: ±0.010" Dimension 'A': ±0.015"

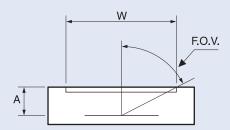
#### 5. Windows

All '**UV**' Enhanced products are provided with QUARTZ glass windows,  $0.027 \pm 0.002$ " thick.

All 'XUV' products are provided with removable windows.

All 'DLS' PSD products are provided with A/R coated glass windows.

All 'FIL' photoconductive and photovoltaic products are epoxy filled instead of glass windows.



$$F.O.V. = \tan^{-1} \left(\frac{W}{2A}\right)$$



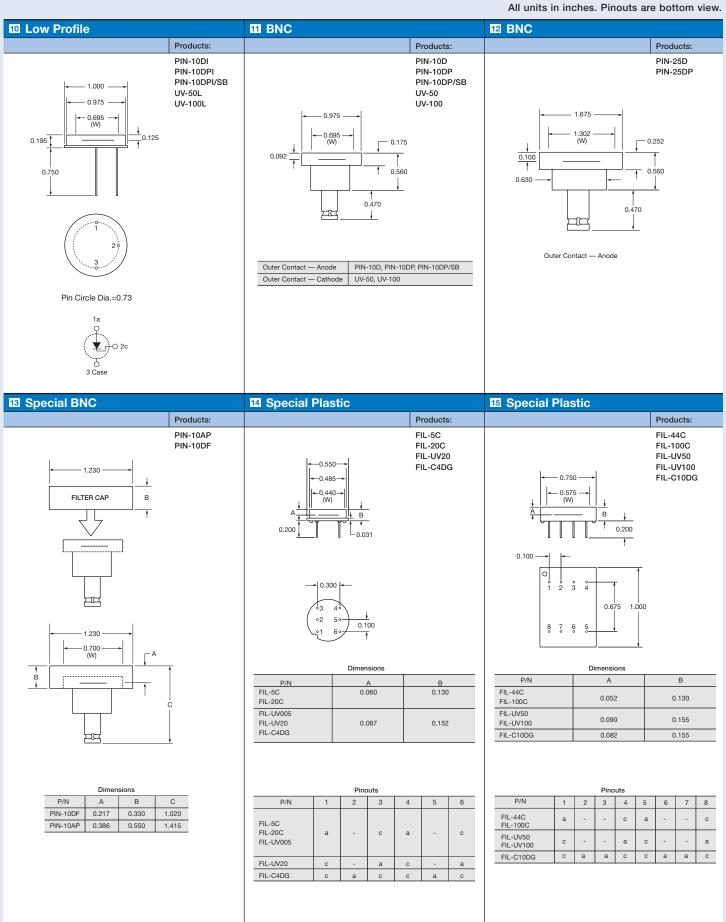
For Further Assistance Please Call One of Our Experienced Sales and Applications Engineers

310-978-0516



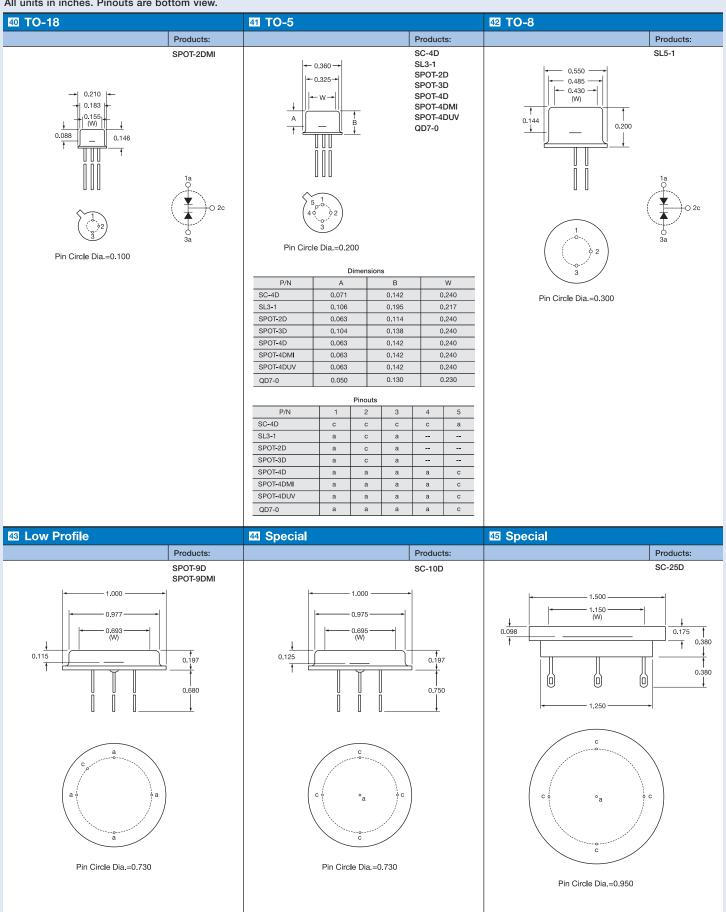
On the Internet at www.osioptoelectronics.com

# **Mechanical Specifications**



# Mechanical Specifications

All units in inches. Pinouts are bottom view.



# **Mechanical Specifications**

All units in inches.

